

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Chien-Hsing Lee</td> <td>04/01/2009</td> </tr> <tr> <td>Tsung-Min Hsieh</td> <td>04/01/2009</td> </tr> <tr> <td>Shao-Yi Wu</td> <td>04/01/2009</td> </tr> </tbody> </table>		Name	Execution Date	Chien-Hsing Lee	04/01/2009	Tsung-Min Hsieh	04/01/2009	Shao-Yi Wu	04/01/2009				
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>Solid State System Co., Ltd.</td> </tr> <tr> <td>Street Address:</td> <td>5F-1, No. 22, Taiyuen Street,</td> </tr> <tr> <td>Internal Address:</td> <td>Jubei City</td> </tr> <tr> <td>City:</td> <td>Hsinchu</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> <tr> <td>Postal Code:</td> <td>302</td> </tr> </table>		Name:	Solid State System Co., Ltd.	Street Address:	5F-1, No. 22, Taiyuen Street,	Internal Address:	Jubei City	City:	Hsinchu	State/Country:	TAIWAN	Postal Code:	302
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CORRESPONDENCE DATA													
<p>Fax Number: (949)660-0809</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Email: usa@jcpigroup.com.tw</p> <p>Correspondent Name: JIANQ CHYUN INTELLECTUAL PROPERTY OFFICE</p> <p>Address Line 1: 7F-1, NO.100, ROOSEVELT RD., SEC.2</p> <p>Address Line 4: Taipei, TAIWAN 100</p>													
ATTORNEY DOCKET NUMBER:	30767-US-PA												
NAME OF SUBMITTER:	Belinda Lee												
<p>Total Attachments: 2</p> <p>source=30767_assignment#page1.tif</p> <p>source=30767_assignment#page2.tif</p>													

CH \$40.00 12432758

PATENT

500857227

REEL: 022667 FRAME: 0631

ASSIGNMENT

WHEREAS,

1. Chien-Hsing Lee
3. Shao-Yi Wu

2. Tsung-Min Hsieh

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **MICROELECTROMECHANICAL SYSTEM (MEMS) DEVICE WITH
SENSITIVITY TRIMMING CIRCUIT AND TRIMMING PROCESS**

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, Solid State System Co., Ltd.
of 5F-1, No. 22, Taiyuen Street, Jubei City, Hsinchu, Taiwan 302, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Chien-Hsing Lee

Date: 4/1/2009

Sole or First Joint Inventor: Chien-Hsing Lee

Signature: Tsung-Min Hsieh

Date: 4/1/2009

Second Joint Inventor (if any): Tsung-Min Hsieh

Signature: Shao-Yi Wu

Date: 4/1/2009

Third Joint Inventor (if any): Shao-Yi Wu